# 6-487509-1 ACTIVE

#### TRIO-MATE

TE Internal #: 6-487509-1

Connector Assembly, Wire-to-Board, 12 Position, 2.54 mm [.1 in]

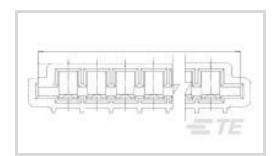
Centerline, 1 Row, Vertical, Socket, Tray, Low, Vertical, TRIO-MATE,

FFC Connectors

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > FFC Connectors



FFC Connector Product Type: Connector Assembly

Connector System: Wire-to-Board

Number of Positions: 12

Centerline (Pitch): 2.54 mm [ .1 in ]

Number of Rows: 1

### **Features**

## **Product Type Features**

| Connector & Contact Terminates To | Printed Circuit Board |
|-----------------------------------|-----------------------|
| Connector & Housing Type          | Receptacle            |
| FFC Connector Product Type        | Connector Assembly    |
| Connector System                  | Wire-to-Board         |
| Insertion Force Type              | Low                   |
| Configuration Features            |                       |
| Number of Positions               | 12                    |
| Number of Rows                    | 1                     |
| PCB Mount Orientation             | Vertical              |
| Body Features                     |                       |
| Primary Product Color             | Black                 |
| Contact Features                  |                       |
|                                   |                       |

Contact Mating Area Plating Material

Contact Mating Area Plating Material Finish Bright

Contact Mating Area Plating Material Thickness

Contact Type Socket

Contact Current Rating (Max)

1 A

Tin (Sn)

Phosphor Bronze

5 μm[200 μin]



## **Termination Features**

| Termination Method to PCB      | Through Hole - Solder      |
|--------------------------------|----------------------------|
| Termination Post & Tail Length | 4.06 mm[.16 in]            |
| Mechanical Attachment          |                            |
| Mating Alignment Type          | Polarization               |
| PCB Mount Retention Type       | Z Bend                     |
| PCB Mount Retention            | With                       |
| Mating Retention               | Without                    |
| Mating Alignment               | With                       |
| Panel Mount Feature            | Without                    |
| Connector Mounting Type        | Board Mount                |
| Housing Features               |                            |
| Housing Material               | Thermoplastic              |
| Centerline (Pitch)             | 2.54 mm[.1 in]             |
| FFC Cable Entry                | Vertical                   |
| Dimensions                     |                            |
| PCB Thickness (Recommended)    | 1.57 mm[.062 in]           |
| Usage Conditions               |                            |
| Operating Temperature Range    | -55 – 105 °C[-67 – 221 °F] |
| Operation/Application          |                            |
| Circuit Application            | Signal                     |
| Industry Standards             |                            |
| UL Flammability Rating         | UL 94V-0                   |
| Packaging Features             |                            |
| Packaging Quantity             | 480                        |
|                                |                            |

## **Product Compliance**

Packaging Method

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant                  |
|---|----------------------------|
| EU ELV Directive 2000/53/EC                   | Compliant                  |
| China RoHS 2 Directive MIIT Order No 32, 2016 | 有害物质含量符合标准要求 No Restricted |

Tray

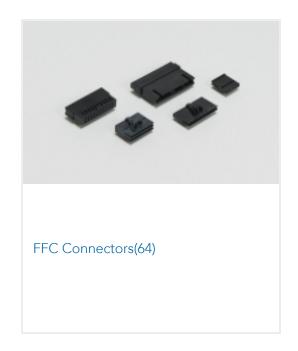


|  | Substance(s) Above Threshold  |
|--|---|
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC |
| Halogen Content                        | Not Low Halogen - contains Br or Cl > 900 ppm.  |
| Solder Process Capability              | Wave solder capable to 265°C  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Also in the Series | TRIO-MATE



# Customers Also Bought





Purpose Solution with Fuse Options

















## **Documents**

## **Product Drawings**

TRIOMATE ASY V12P L=4.064,LDFR

English

## **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_6-487509-1\_G.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_6-487509-1\_G.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_6-487509-1\_G.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

Trio-Mate Flat Flexible Discrete Circuit .100 Connectors

English

**Application Specification** 

Japanese

**Application Specification** 

English